

# 6A, 650V SiC Merged PIN Schottky Diode

#### **FEATURES**

- Max junction temperature 175°C
- MPS structure for high ruggedness to forward current surge events
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V<sub>F</sub>
- RoHS compliant
- Halogen-free

<b>APP</b>	LICATI	IONS
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- General purpose
- Switch mode power supplies
- Power factor correction

### **MECHANICAL DATA**

• Case: TO-220AC-2L

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Polarity: As circuit diagram

• Weight: 2.03g (approximately)

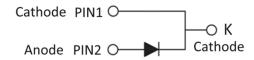
KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l <sub>F</sub>	6	Α		
$V_{RRM}$	650	V		
I <sub>FSM</sub>	44	Α		
T <sub>J MAX</sub>	175 °C			
Package	TO-220AC-2L			
Configuration	Single die			







TO-220AC-2L



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	VALUE	UNIT
Repetitive peak reverse voltage		V <sub>RRM</sub>	650	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	455	V
Continuous Rectified Forward Current @ T <sub>J</sub> = 160°C		l <sub>F</sub>	6	Α
Surge peak forward current 10ms single half	$T_C = 25^{\circ}C$	IFSM	44	Α
sine-wave superimposed on rated load	T <sub>C</sub> = 125°C		36	Α
Junction temperature		TJ	-55 to +175	°C
Storage temperature		T <sub>STG</sub>	-55 to +175	°C



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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	MAX	UNIT
Junction-to-case thermal resistance	Rejc	1.56	1.90	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	VF	1.13	-	V
	I <sub>F</sub> = 6A, T <sub>J</sub> = 25°C		1.32	1.45	V
	I <sub>F</sub> = 3A, T <sub>J</sub> = 150°C		1.16	-	V
	I <sub>F</sub> = 6A, T <sub>J</sub> = 150°C		1.52	-	V
	I <sub>F</sub> = 3A, T <sub>J</sub> = 175°C		1.19	-	V
	I <sub>F</sub> = 6A, T <sub>J</sub> = 175°C		1.59	1.85	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C	l <sub>R</sub>	-	20	μA
	T <sub>J</sub> = 175°C	IR	-	200	μA
Junction capacitance	$f = 1MHz, V_R = 1V$		292	-	pF
	$f = 1MHz, V_R = 200V$	CJ	41.8	-	pF
	f = 1MHz, V <sub>R</sub> = 400V		30.5	-	pF
Capacitive Charge	V <sub>R</sub> = 400V	Qc	20.8	-	nC

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSCDT06065G1	TO-220AC-2L	50 / Tube		



### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.1 Typical Forward Characteristics

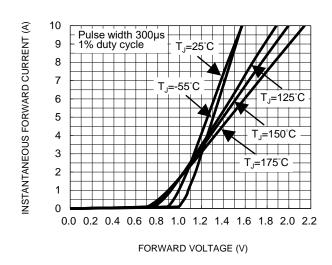


Fig.3 Peak forward current versus case temperature

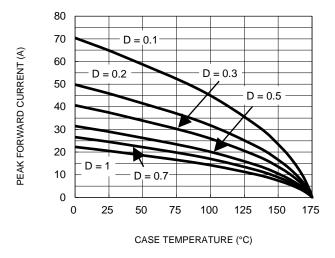


Fig.5 Typical Capacitive Charge

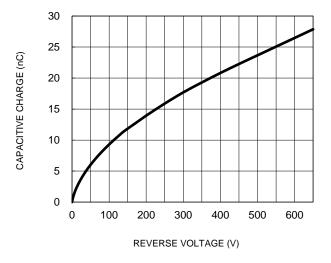
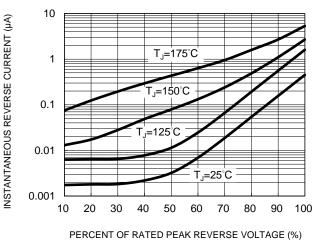


Fig.2 Typical Reverse Characteristics



**Fig.4 Typical Junction Capacitance** 

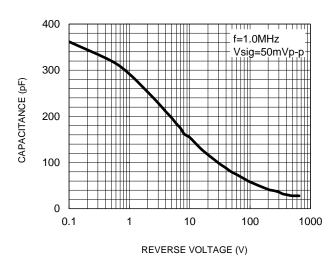
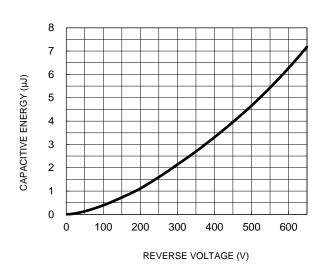


FIG.6 Typical Capacitance Stored Energy

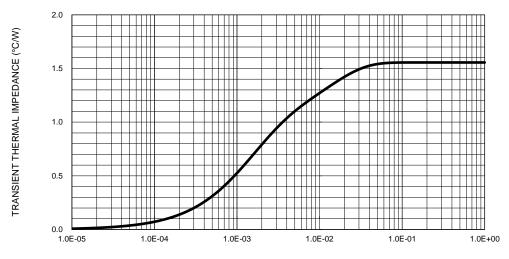




## **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.7 Typical Transient Thermal Characteristics** 

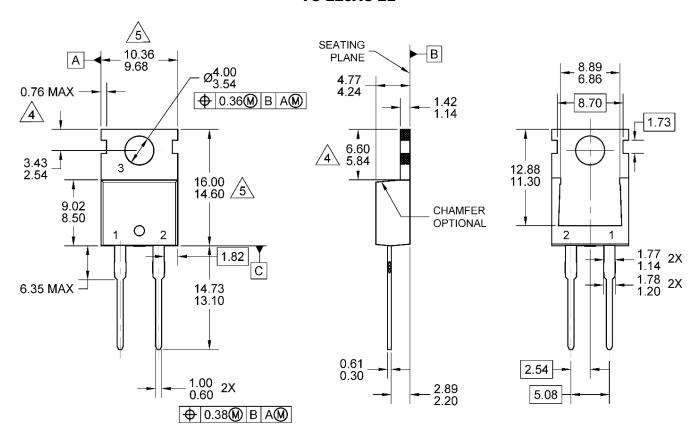


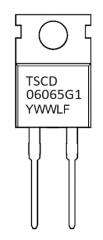
PULSE DURATION (s)



### **PACKAGE OUTLINE DIMENSIONS**

#### TO-220AC-2L





## MARKING DIAGRAM

Y = YEAR CODE

WW = WEEK CODE (01~52)

L = LOT CODE (1~9, A~Z)

F = FACTORY CODE

#### NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-220, VARIATION AC, ISSUE K.
- THE DEFINED ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. SLOT AND NOTCH MAY APPEAR IN THIS ZONE.
- THIS DO NOT INCLUDE MOLD FLASH.
  THESE DIMENSIONS ARE MEASURED AT
  THE OUTERMOST EXTREME OF THE
  PLASTIC BODY.
  - 6. DWG NO REF: HQ2SD07-TO220ACSiC-119 REV A.



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